



Two-Part Epoxy
Technical Datasheet

Features & Benefits

- Adhesion to a wide variety of substrates
- Full cure at room temperature
- FDA Compliant formulation
- High shear and peel strength
- Good impact strength

Description

PERMABOND® ET5147 is a 2:1 mixable epoxy adhesive. It has excellent resistance to impact and vibration and is ideal for structural bonding of metal, wood, composites and certain plastics. Its rapid cure speed coupled with its structural strength makes this adhesive suitable for a wide variety of applications. ET5147 is high strength and has excellent environmental durability.

Permabond ET5147 has been specifically formulated to meet the requirements of:

FDA 175.105 and 175.300

Physical Properties of Uncured Adhesive

	ET5147A	ETS147B
Chemical composition	Epoxy Resin	Polyamine Hardener
Appearance	White	Ivory
Viscosity @ 25°C	20rpm: 25,000- 40,000 mPa.s (cP) 2rpm: 80,000- 160,000 mPa.s (cP)	
Specific gravity	1.3	1.2

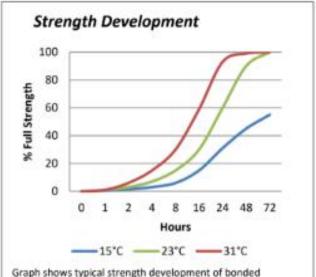
Typical Curing Properties

Mix ratio by volume	2:1
Maximum gap fill	2 mm 0.08 in
Usable / pot life @23°C 2+1g	40-60 mins
Handling time @23°C	3-5 hours
Working strength	@23°C: 16 hours @60°C: 30 minutes
Full cure	@23°C: 72 hours @60°C: 1 hour

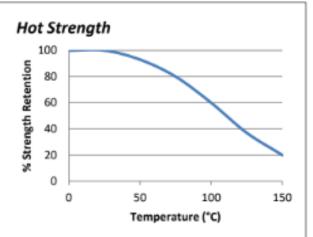
Typical Performance of Cured Adhesive

Shear strength* (ISO4587)	Mild steel: 18-20 N/mm ² (2600 -2900 psi) Stainless steel: 15-19 N/mm ² (2200 -2800 psi) Aluminium: 10-14 N/mm ² (1450 -2000 psi)
Peel strength (aluminium) (ISO4578)	40-70 N/25mm (9-16 P(W)
Hardness (ISO868)	68-72 Shore D
Glass transition temperature Tg	50-60°C (122-140°F)
Dielectric strength	15-25 kV/ mm

^{*}Strength results will vary depending on the level of surface preparation and gap.



components. An increase of 8°C in temperature will halve the cure time. Lower temperatures will result in a slower cure time.



"Not strength" shear strength tests performed on mild steel. Fully cared specimens conditioned to pull temperature for 30 minutes before testing at temperature.

ET5147 can withstand higher temperatures for brief periods (such as for paint baking and wave soldering processes) providing the joint is not unduly stressed. The minimum temperature the cured adhesive can be exposed to is -40°C (-40°F) depending on the materials being bonded.

Additional Information

This product is not recommended for use in contact with strong oxidizing materials.

Information regarding the safe handling of this material may be obtained from the safety data sheet.

Users are reminded that all materials, whether innocuous or not, should be handled in accordance with the principles of good industrial hygiene.

This Technical Datasheet (TDS) offers guideline information and does not constitute a specification.

Storage & Handling

Storage Temperature 5 to	25°C (41 to 77°F)
--------------------------	-------------------

Surface Preparation

Surfaces should be clean, dry and grease-free before applying the adhesive. Use a suitable solvent (such as acetone or isopropanol) for the degreasing of surfaces. Some metals such as aluminium, copper and its alloys will benefit from light abrasion with emery cloth (or similar), to remove the oxide layer.

Directions for Use

- Dual cartridges:
 - a) Insert the cartridge into the application gun and guide the plunger into the cartridge.
 b) Remove the cartridge cap and dispense material until both sides are flowing.
 c) Attach the static mixer to the end of the cartridge and begin dispensing the material.
- 2. Apply material to one of the substrates.
- Join the parts. Parts must be joined within 40-60 minutes of mixing the two epoxy components.
- Large quantities and/or higher temperature will decrease the usable life or pot life.
- Apply pressure to the assembly by clamping for 5 hours or until handling strength is obtained.
- Full cure will be obtained after 72 hours at 25°C (77°F). Heat can be used to accelerate the curing process.

Video Links

Surface preparation:

https://youtu.be/8CMOMP7hXjU



Two-part epoxy directions for use: https://youtu.be/GRX1RyknYqc

